**Lower Total Cost of Ownership (TCO)**

Nuvogo™ 1000XL ensures reduced total cost of ownership while meeting the industry’s increasing demands for high-end mass production. With lower service cost per print, the system offers manufacturers a significantly lower TCO to quickly achieve maximum ROI. Setting a new industry standard, the system provides efficient power consumption while still providing a powerful light source and the most sophisticated optical and electronic systems. Nuvogo™ 1000XL supports a variety of resist types enabling manufacturers to select lower cost resists to further reduce operational costs.

### Specifications

<table>
<thead>
<tr>
<th>Min. SRO</th>
<th>75μm</th>
</tr>
</thead>
<tbody>
<tr>
<td>Min. Dam Size</td>
<td>50μm</td>
</tr>
<tr>
<td>Edge Roughness**</td>
<td>±2.0μm</td>
</tr>
<tr>
<td>Imaging Energy Range</td>
<td>25 - 2,200</td>
</tr>
<tr>
<td>Registration Accuracy FpD***</td>
<td>±10μm</td>
</tr>
<tr>
<td>Side-to-Side Registration FpB***</td>
<td>25μm</td>
</tr>
<tr>
<td>Max. Substrate Size</td>
<td>660mm x 812mm</td>
</tr>
<tr>
<td>Max. Exposure Area</td>
<td>635mm x 812mm</td>
</tr>
<tr>
<td>Substrate Thickness***</td>
<td>0.025mm - 8mm</td>
</tr>
<tr>
<td>Depth-of-Focus</td>
<td>±300μm</td>
</tr>
</tbody>
</table>

**Applications**

- Flex Solder Mask
- Inner layers and outer layers (especially high energy resists)
- Sequential build-up layers

**System Options**

- Hole-free inner layer registration
- Stamping ( serialization, scale factor, date / time)
- 2D barcode stamp
- Win Scaling
- Partial Scaling
- Group Scaling and stamping
- Automation options:
  - DLU - DI Loading Unit
  - Flipper
  - Loader & unloader
- Additional vacuum customization plate

### Nuvogo™ 1000XL for Patterning

| Throughput* [prints/h] Max. [Patterning] | 290 |
| Min. Feature Size** | 24μm |
| Address Resolution | 2.0μm |

* Depends on resolution and photoresist properties
** All values are ±0.5, full format
*** Including DFR or solder resist thickness
- Specifications are subject to change without notice.

www.orbotech.com/pcb
NUVOGO™ 1000XL
The New Way of Imaging

Nuvo™ 1000XL is the latest addition to Orbotech’s Nuvo™ family of leading Direct Imaging (DI) solutions. Utilizing a high power laser and unique MultiWave Laser Technology™, the Nuvo™ 1000XL provides maximum flexibility on a wide range of materials and applications. Incorporating Orbotech’s field-proven Large Scan Optics (LSO) Technology™ with its high depth-of-focus, it is a perfect match for Flex Solder Mask applications that demand fine structures on changing topography. This powerful system is designed for fast throughput while maintaining optimal quality.

Benefits

Leading Mass Production Digital Imaging
- In-line solution and fully-integrated automation for seamless production
- Optimized imaging time with dual table transport mechanism
- Fast and easy setup; operator friendly
- Clean, handling-free production environment
- Up to 6,500 panels / day / line using automated in-line solution (290 panels per hour, per line) at a high laser power

MultiWave Laser Technology™ for Maximum Resist Flexibility
- Embedded MultiWave Laser Technology™ ensures small undercut and excellent side walls
- Addresses a wide range of materials and applications

Highest Imaging Quality With LSO Technology™
- Unique optics design for optimal line-structure and solder dam uniformity
- High depth-of-focus up to ±300μm for unmatched quality on changing surface topographies (especially for Solder Mask Flex applications)
- Advanced scaling modes for optimal registration accuracy down to ±10μm

Lower Total Cost of Ownership (TCO)
- Optimized service cost per print
- Increased overall efficiency for significant long-term savings
- Suited for a wide variety of resists, offering the option to use lower-cost materials

Nuvogo™ 1000XL for State-of-the-Art Mass Production Digital Imaging

As part of the Nuvo™ family, the Nuvogo™ 1000XL utilizes Orbotech’s high power MultiWave Laser Technology™. Equipped with the industry’s most advanced optics and electronics, Nuvogo™ 1000XL is designed to achieve fine structures at unmatched speeds. Its dual table transport mechanism achieves maximum use of system time for panel imaging. Furthermore, the system’s fast setup capabilities and automatic acquisition of targets facilitate smooth job changes. Nuvogo™ 1000XL also operates in a clean, hands-free environment, thus ensuring no handling damage.

Orbotech High Power MultiWave Laser Technology™ for Maximum Resist Flexibility

Nuvogo™ 1000XL is powered by Orbotech’s high power MultiWave Laser Technology™ which delivers unparalleled structure quality on a variety of resists and solder resists. It also provides maximum flexibility to match any solder resist and to fit all forms and processes. The adaptable multi-wavelength laser also minimizes undercut to allow extremely smooth side walls.

Highest Imaging Quality With LSO Technology™

Registration Accuracy
Registration accuracy down to ±10μm, enabling tight Solder Mask clearances.

Innovative Scaling Modes
- Auto Scaling / Fixed Scaling / Group Scaling
- Partial Scaling – sub-area registration for thin core layers

Depth-of-Focus (D.o.F.)
- D.o.F up to ±300μm for overcoming the most challenging surface topography changes and any distortion or abnormalities with the most advanced image quality
- Single scan allows uniform imaging of the entire panel

Resolution and Line Uniformity
- Best line uniformity (down to 24μm in patterning)
- Allows solder dams down to 50μm and SRO down to 75μm

Ease-of-Use
- Operator-friendly, intuitive graphical user interface
- Seamless connectivity to CAM ensures an easy set-up
- Recognizes a wide array of different target types to meet any production demands
- Supports side-by-side Flex imaging

Traceability
- Enables panel tracking by marking: serial number stamp; sub-panel and PCB; date and time stamp; scaling stamp and machine ID by alphanumeric stamping or 1-D barcode / 2-D barcode (Data Matrix Code).
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LSO Technology™
MultiWave Laser Technology™